



LED SPECIFICATIONS

Part No. 3DZ-V5R30F-TNB

PREPARED BY 3DZ		
ML	JK	

■ Features

- Round Type type lamp
- 5mm resin mold type
- Water clear transparent type lens
- High luminous intensity
- Chip material based GaN

■ Absolute Maximum Ratings(Ta=25°C)

Parameter	Symbol	Value	Unit
Power Dissipation	P _d	120	mW
Continuous Forward Current	I _F	30	mA
Peak Forward Current ※1	I _{FP}	100	mA
Reverse Voltage	V _R	5	V
Operating Temperature	T _{opr}	-25 ~ 80	°C
Storage Temperature	T _{stg}	-40 ~ 100	°C
Soldering Temperature	T _{sol}	260 (5sec)	°C

※1 Duty ratio = 1/10, Pulse width = 0.1ms

■ Electro-optical Characteristics(Ta=25°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward Voltage	V _F	I _F = 20mA	3.0	3.4	4.0	V
Reverse Current	I _R	V _R = 5V	-	-	10	μA
Luminous Intensity	I _v	I _F = 20mA	500		1500	mcd
Viewing angle	2θ _{1/2}	I _F = 20mA	-	35	-	deg.
Spectrum radiation Bandwidth	Δλ	I _F = 20mA	410	415	420	nm

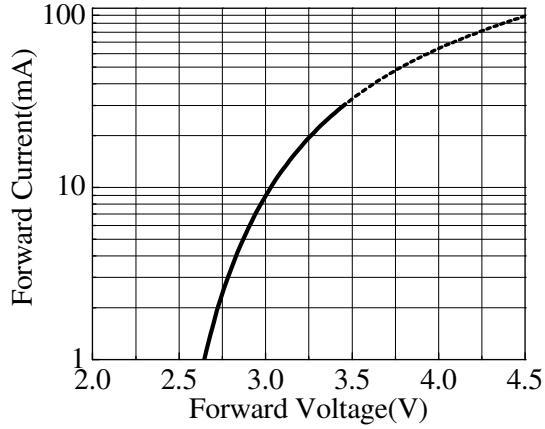
※2 Luminous Intensity is tested by a tester calibrated by CAS 140B(CIE LED_B) and has an accuracy of 10%

※3 Viewing angle is the angle until 50% of brightness measured from the front part of LED.

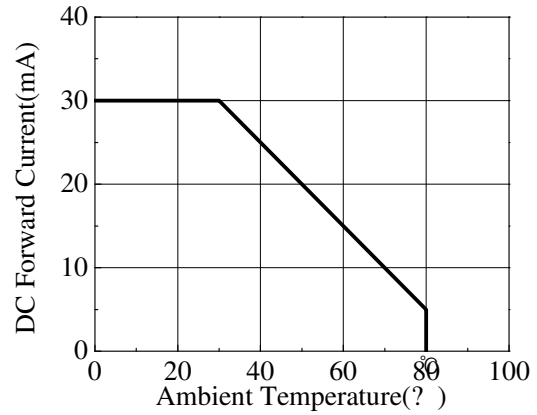
※4 Dominant wavelength has an accuracy of ±1nm.

■ Typical Curves

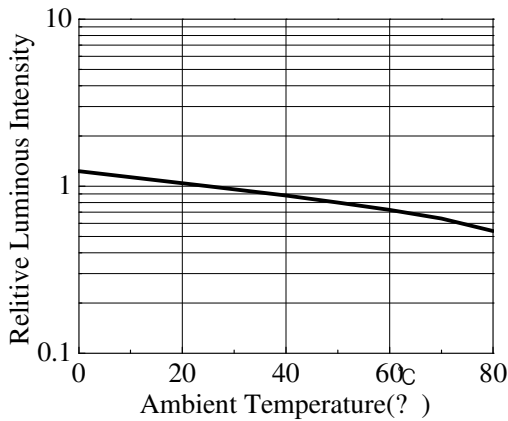
Forward Current vs. Forward Voltage



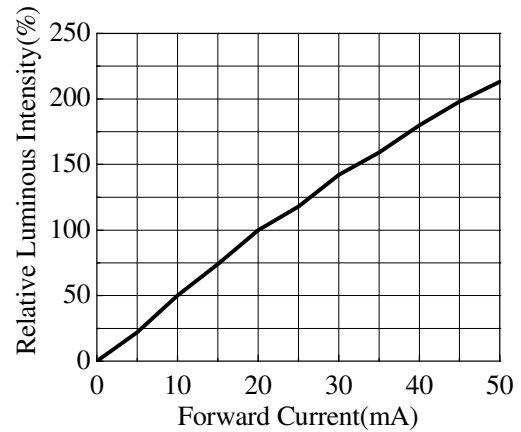
Forward Current vs. Ambient Temperature



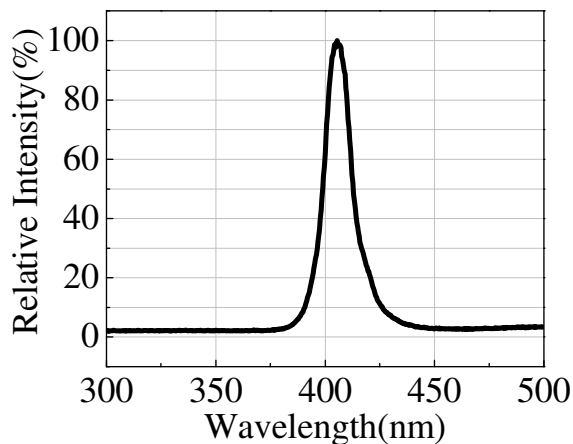
Relative Luminous Intensity vs. Ambient Temperature



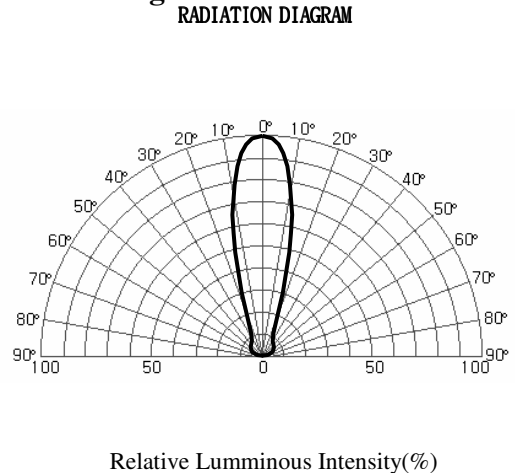
Relative Luminous Intensity vs. Forward Current



Relative Intensity vs. Wavelength

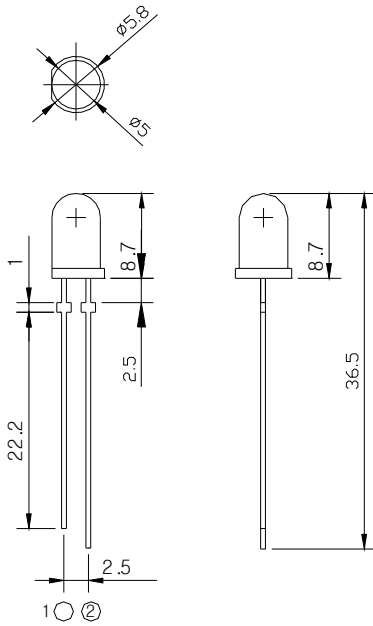


Radiation Diagram

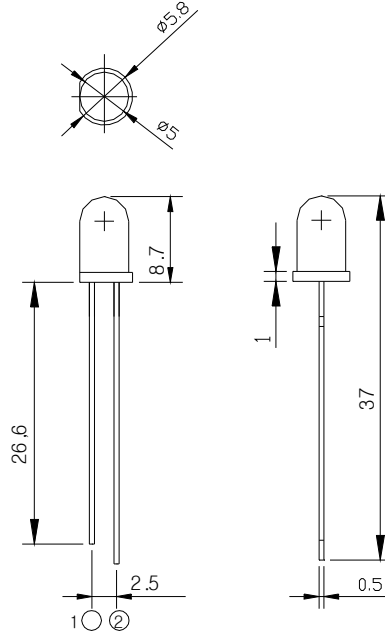


■ Out Line Dimension

- With Stopper



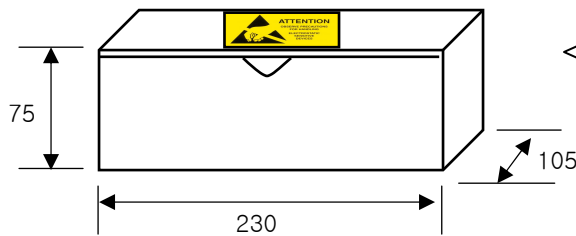
- Without Stopper



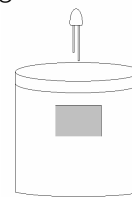
■ Taping Dimension & Packing

- Bulk Packing

Inner Box



Bag packing



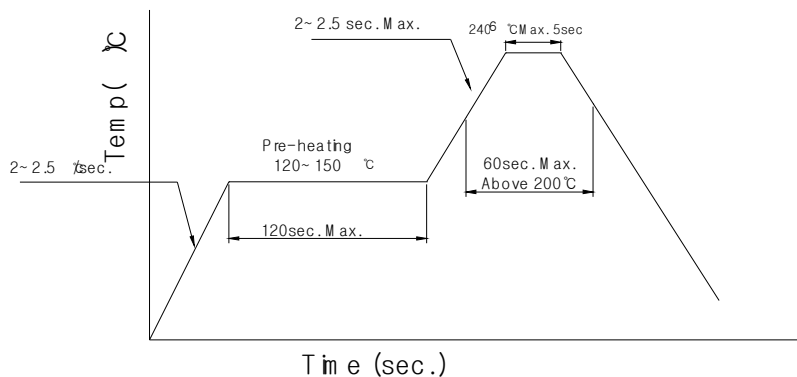
Label

- Maximum Inner Box 20 / 1 Box
30,000 pcs/ 1 Box
- Out box material : Carton

■ Precaution in use

① Soldering Conditions

- When soldering Dome LED , Heat may affect the electrical and optical characteristics of the LEDs.
- In soldering, do not stress the lead frame and the resin part under the high temperature.
- The epoxy part should be protected from mechanical stress or vibration until the Dome LEDs return to room temperature after soldering.
- Preliminary heating to be at 180°C max. for 120 Seconds max.
- Soldering heat to be at 260°C max. for 5sec. Max.
- For manual Soldering is Not more than 3sec @MAX350°C , under soldering iron



② Storage

- Use within 7 days after opening packing. Store in 10 to 30 °C Dome LED lead frames are plated silver. The silver surface may be affected by environment which contain corrosive gases and so on. Please avoid condition which may cause the Dome LED to corroded, tarnish or discolor.

③ Static Electricity

- Static electricity or surge voltage damages the Dome LEDs. It is recommended that a wrist band or an anti-electrostatic glove be used when handling the LEDs.
- A tip soldering iron is requested to be grounded. An ionizer should also be installed where risk of static.
- All devices, equipment and machinery must be properly grounded (via 1MΩ). It is recommended that measures be taken against surge voltage to the equipment that mounts the Dome LEDs.

④ Cleaning

- Isopropyl Alcohol or Ethylene Alcohol is recommended in 5 minutes at room temperature. Don't use unspecified chemical may cause crack or haze on the surface of the epoxy resin.
- Before cleaning, a pre-test should be done to confirm whether any damage to the Dome LED will occur.
- Freon solvents should not be used to clean the Dome LEDs because of worldwide regulations.

■ Reliability

- Reliability Test Item

Test Item	Standard Test Method	Test Conditions	Note	Number of Damaged
Resistance to Soldering Heat (Reflow Soldering)	JEITA ED-4701 300 301	Tsld = 260℃, 5sec. (Pretreatment 30 ℃, 70%, 168hrs)	2 times	0/50
Solderability (Reflow Soldering)	JEITA ED-4701 200 303	Tsld = 235 ± 5℃, 5sec. (Lead Solder)	1 time Over 95%	0/50
Thermal Shock	JEITA ED-4701 100 105	-40 ℃ ~ 100 ℃ 15sec 15sec	100 Cycles	0/50
Temperature Cycle	JEITA ED-4701 100 105	-40 ℃ ~ 25℃ ~ 100℃ ~ 25 ℃, 30min 5min 30min 5min	100 Cycles	0/50
High Temp. Storage	JEITA ED-4701 200 201	Ta = 100℃	1000hrs	0/50
Temp. Humidity Storage	JEITA ED-4701 100 103	Ta = 60 ℃, RH = 90%	1000hrs	0/50
Low Temp. Storage	JEITA ED-4701 200 202	Ta = -40 ℃	1000hrs	0/50
Steady State Operating Life Condition	-	Ta = 25 ℃, IF = 20mA	1000hrs	0/50
Steady State Operating Life of High Temp.	-	Ta = 85 ℃, IF = 5mA	1000hrs	0/50
Steady State Operating Life of High Humidity Heat	-	60 ℃, RH = 90%, IF = 15mA	500hrs	0/50
Steady State Operating Life of Low Temp.	-	Ta = -30, IF = 20mA	1000hrs	0/50

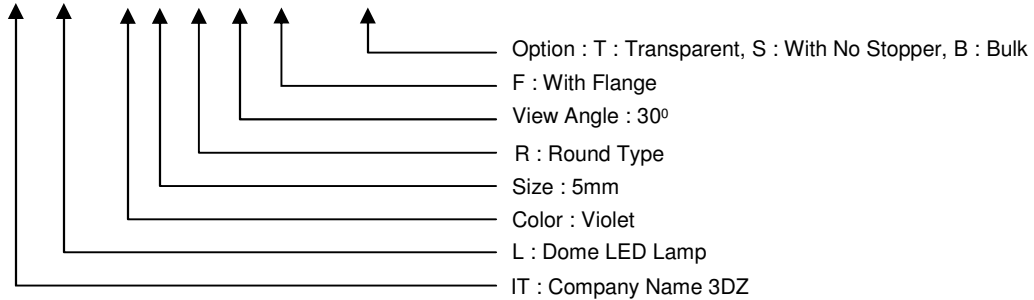
- Criteria for Judging the Damage

Items	Test Conditions	Criteria for judgment
Luminous Intensity (IV)	I _F = 20mA	> 70% of S
Forward Voltage (VF)	I _F = 20mA	Less than 120% of U

* U means the upper limit of specified characteristics, S means initial value.

Part Name Description

3 D Z – V 5 R 30 F - TNB

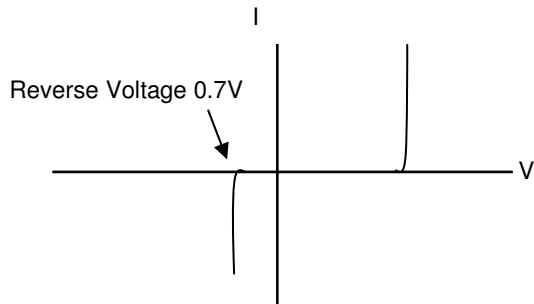


ATTENTION : Electric Static Discharge (ESD) Protection



The symbol shown on the page herein to introduce 'Electro-Optical Characteristics'. ESD protection for GaP and AlGaAs based chips is still Necessary even though they are safe in low static-electric discharge. Material in AlInGaP, GaP, or/and InGaN based chips are static sensitive devices. ESD protection has to considered and taken in the initial design stage. If manual work/process is needed, please ensure the device is well protective From ESD during all the process. LED's ESD Level is 'Class 2' and The range of Forward Voltage is 1999V ~ 3999V.

ATTENTION : Precaution in drive



LED+Zener Diode

- Do not apply reverse voltage more than 0.7V.
- Product with Zener Diode is needed to discriminate the characteristics of product by fixing current and measuring voltage.